

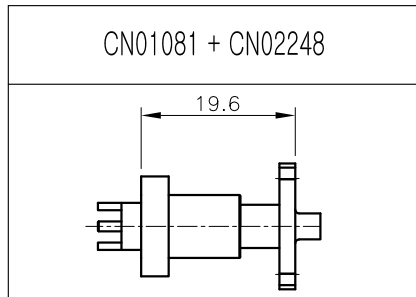
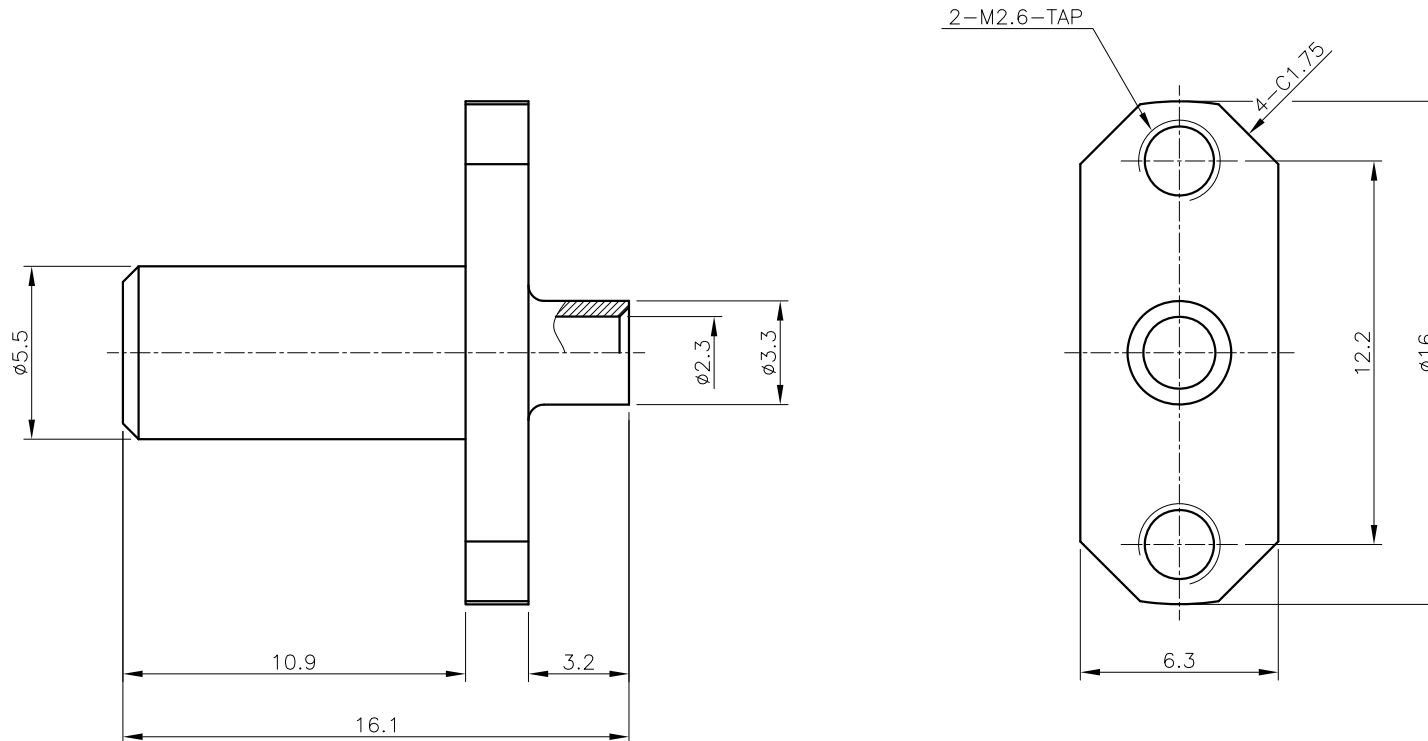
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REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	E.H.KIM	S.J.YOUN	2008.12.08.
1	설번처리No.201008-0004 (BODY 치수 변경)	I.C.KIM	Y.H.CHOI	2010.08.12.
2	설번처리No.202203-0004 (낙시턱 위치 변경 및 핀 사이즈 수정)	S.H.KIM		2022.03.14.
3	절연체 및 핀 돌출 방지 길이 수정	S.H.KIM		2024.07.10.



3	3	INSULATOR	1	TEFLON	White	DIN00092-N/1 (H2017)
3	2	CONTACT	1	BeCu C17300	Gold Plate	DCT00143-5/1 (E2012)
2	1	BODY	1	MBsBD C3604BD-F	Nickel Plate	DBD02303-5/1
	NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal ±0.2	DATE 2024. 07. 10.			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017		
	Angle ±1°	APPROVED BY					
MATERIAL -		CHECKED BY			TITLE PDM50 CABLE JS-2H 85F		
		DRAWN BY S.H.KIM					
FINISH -		SCALE 4/1	UNIT mm		A4	DWG NO. CN02248-7/1	
						REVISION 3	SHEET 1 of 1

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